

July 26, 2006

Vice President and Executive Officer Wasuke Nakano Elected to SEMI Board

On July 12th, SEMI (Semiconductor Equipment and Materials International) announced the results of the election at the annual SEMI membership meeting, which was held during the SEMICON West 2006 exposition in San Francisco. The association's membership elected Wasuke Nakano, Vice President and Executive officer, and General Manager of the Semiconductor Equipment Business Group for Hitachi High-Technologies, to the board of directors.

The SEMI International Board of Directors' election & reelection is held once a year by the member companies. The tenure of the board is two years.

SEMI is an International association of semiconductor, FPD, MEMS (Micro Electro Mechanical Systems) and nanotechnology-related manufacture equipment/material industry. As a global and an advanced organization, it is working for more than 35 years. It is working with 2200 companies all over the world and among these companies, 600 companies are Japanese. Based in 11 cities worldwide, an important subject is faced for the development of related companies, and the cooperation organization of the industry and mutual exchange are supported.

Hitachi High-Technologies can take this election as read that our company's role in the semiconductor manufacturer industry and contribution was evaluated and is a sign of future expectation. In response to this, we will continue to try our best to contribute to the further development of SEMI.



Wasuke Nakano
Vice President and Executive Officer

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